

Supplementary Information

High performance 3D Printed Faradaic Supercapacitor Using Hybrid Nanocomposites of Reduced Graphene oxide/Mn_xO_y-based Electrodes

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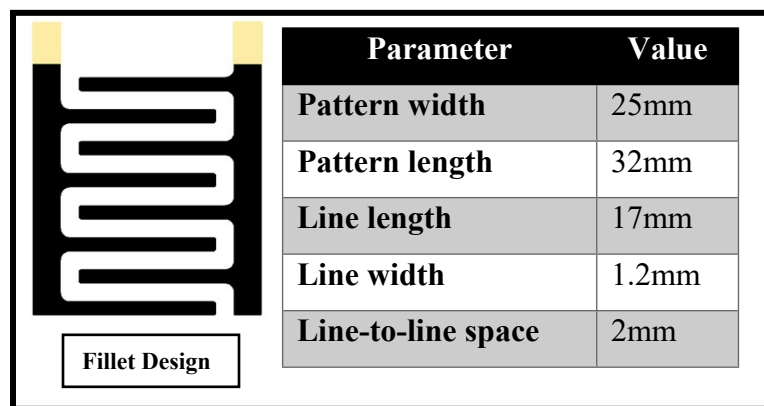


Figure S 1. Interdigitated fillet printing pattern of the silver current collector, active layers, and printed design dimensions. The shape and size of the printed pattern can be customized and will be studied in the future works. In this study, fillet pattern was developed to handle the convenience, printer compatibility, and reproducibility while improving the strength of printed design by avoiding right angle and also keeping consistent printing.

FDM printer

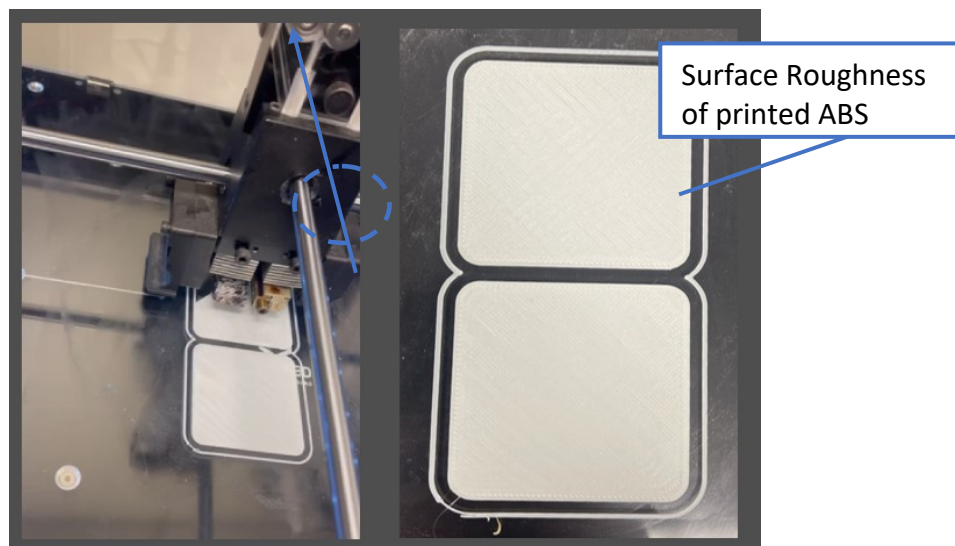


Figure S 2. The filament printed ABS substrate fabricated by an FDM printer. The role of the substrate is to support all other functional layers including current-collector, active, and Gel Polymer layers. As you see in this figure, the surface roughness of ABS printed substrate was maintained to help with the ink adhesion.

Examples of substrates failures:

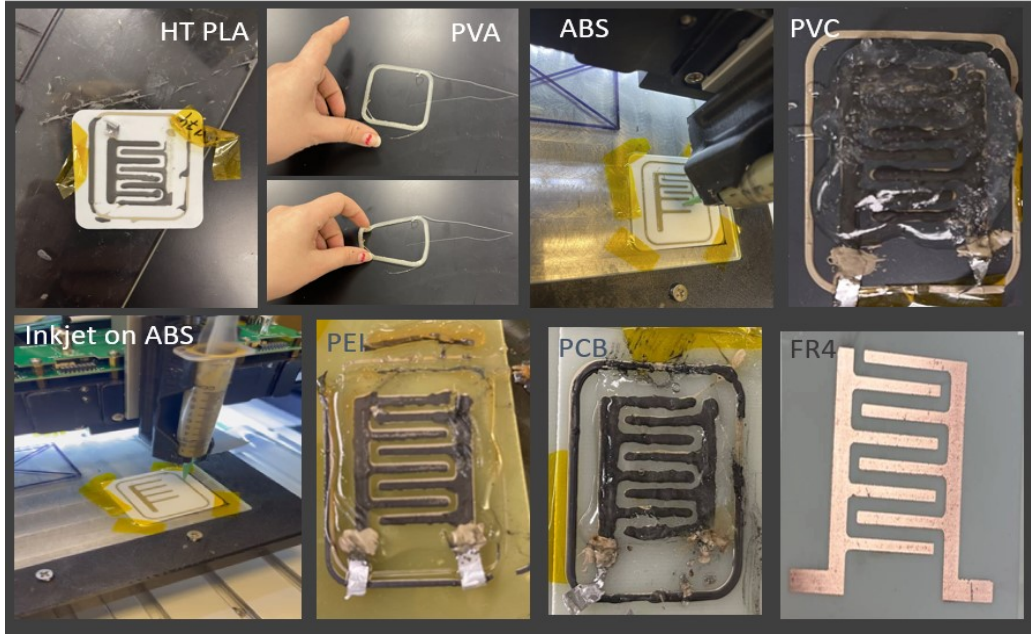


Figure S 3. Various prefabricated substrates were investigated in this study (such as Polyvinyl alcohol (PVA), High Temperature Polylactide (HTPLA), Polyvinyl chloride (PVC), Polyetherimide (PEI), etc.). As illustrated in this figure, the printing failures on the substrate were the main reason for using our custom 3D printed ABS substrate instead of these prefabricated commercially existing substrates to fabricate an all-printed SC design. The printed ABS substrate could support the current collector, active and gel polymer layer and it was perfectly compatible with the annealing temperature required for each layer. Therefore, no thermal degradation (cracking, chipping, and breaking) was observed. ABS did not show any adhesion failure and it was also compatible with the solvent we used to prepare the gel polymer layer.

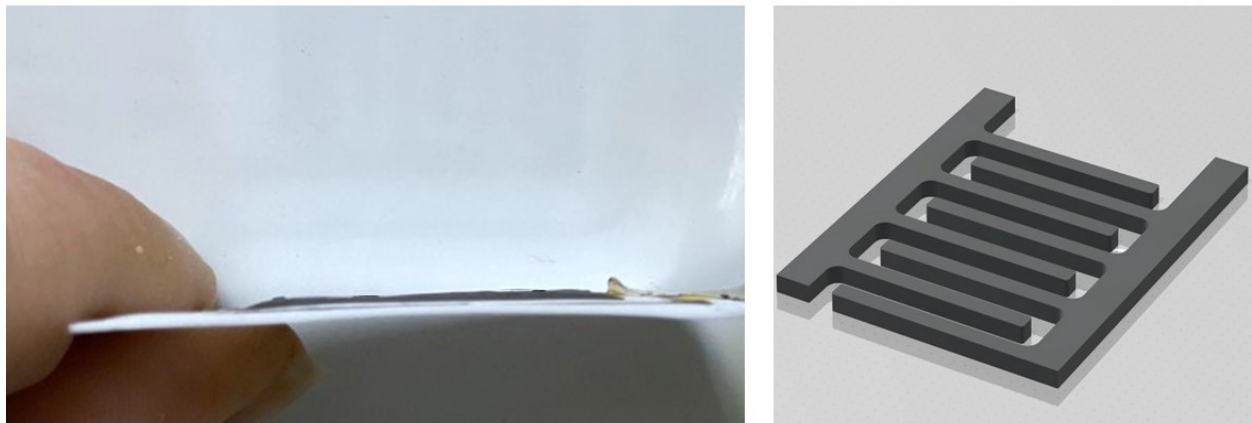


Figure S 4. Design pattern created with the solid work with 1mm height of each layer.

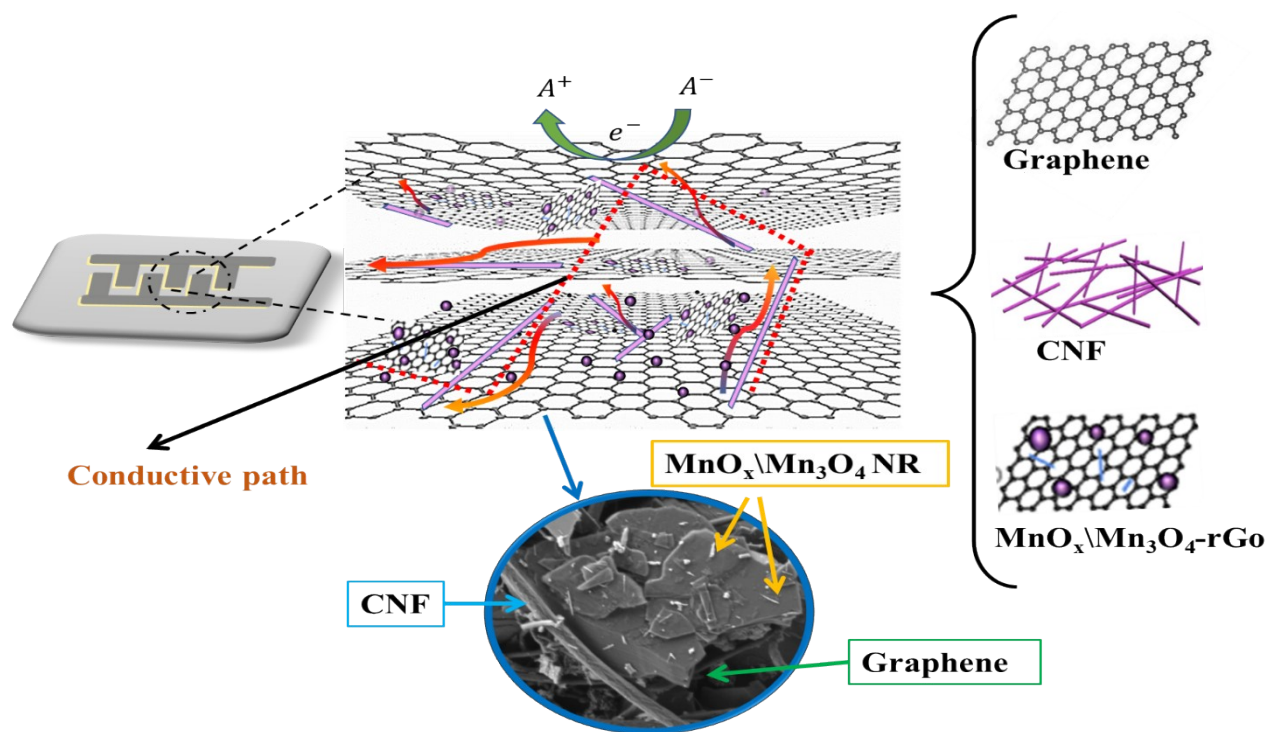


Figure S 5. Schematic illustration of the percolated conductive network of CNFs, $\text{MnO}_x/\text{Mn}_3\text{O}_4$ -rGo on graphene nanosheets.

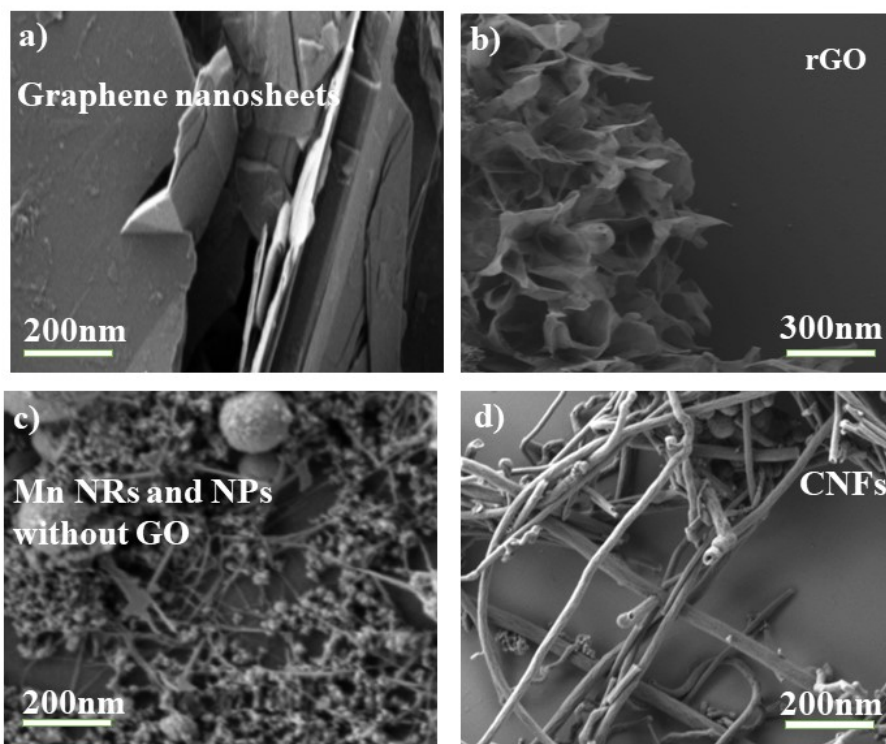


Figure S 6. SEM micrographs of all active-printed electrode constituents in their respective pristine phases: (a) graphene nanosheets, (b) reduced graphene-oxide (rGO) (c) Mn_xO_y nano-architectures obtained from the laser ablation of Mn target during 8 min, and (d) Carbon nanofibers (CNTs)

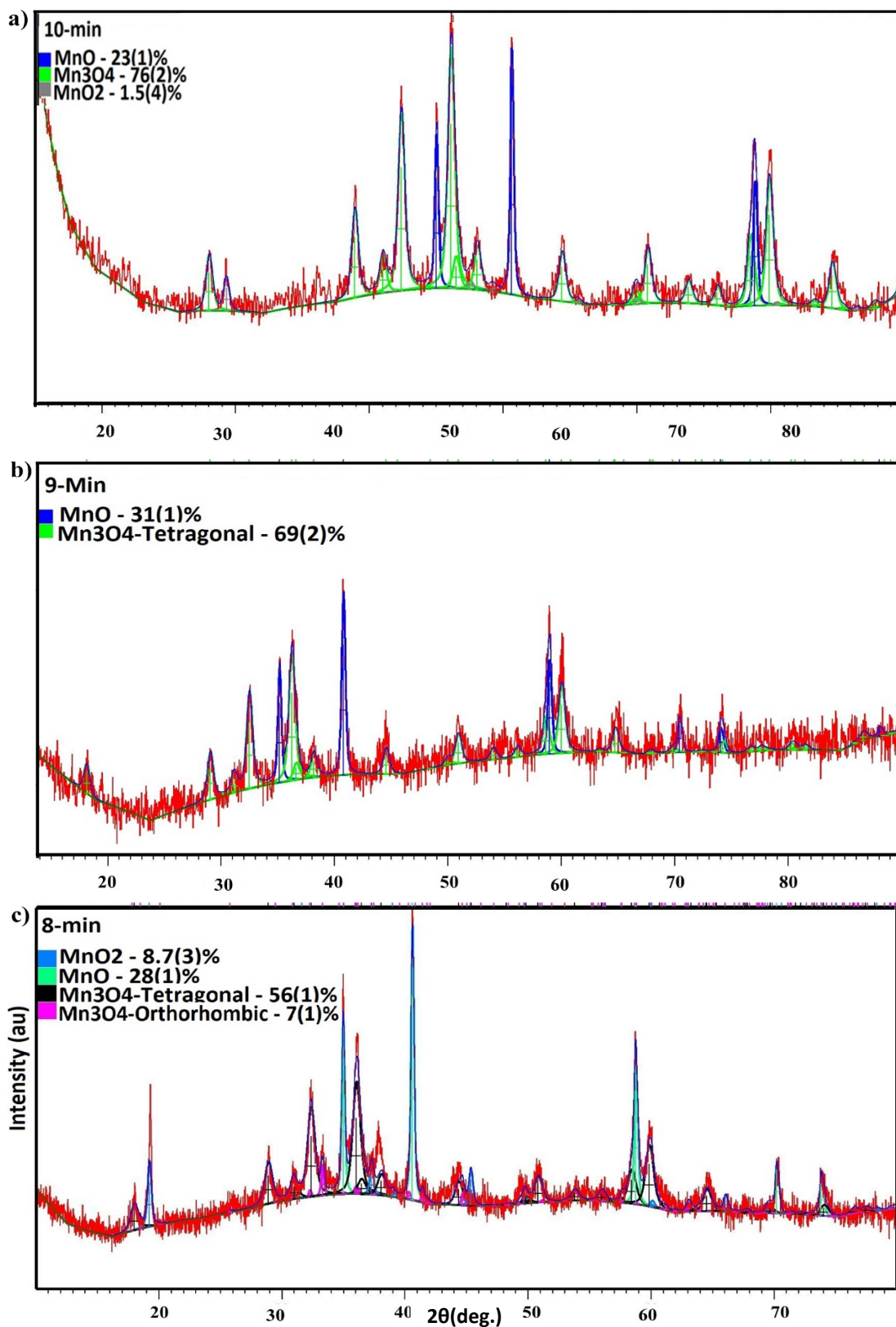


Figure S 7. XRD peak patterns for samples prepared at 8- 9- and 10 mins ablation time. These patterns indicate that various manganese oxide structures could be detected in the nanocomposites formed during the LASiS-induced synthesis of the HNCs.

XRD patterns of samples prepared under 9- and 10- mins of ablation times indicate negligible presence of MnO_2 crystal structures in the HNCs structure while its mass ratio for the sample prepared under 8- mins ablation time is around 9%.

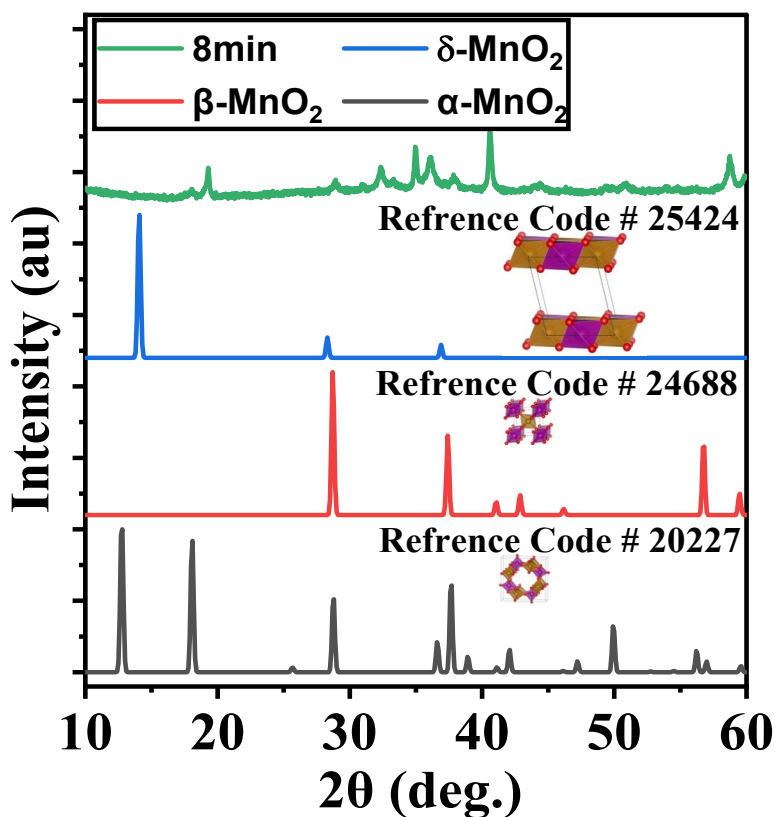


Figure S 8. XRD pattern of the Laser derived $\text{MnO}_x/\text{Mn}_3\text{O}_4$ -rGO HNCs prepared under 8 minutes ablation time and comparison with standard XRD pattern of α -, β - & δ - MnO_2 . There is a distinct peak for α - MnO_2 around $2\theta=18$ and $2\theta=39$ (deg).

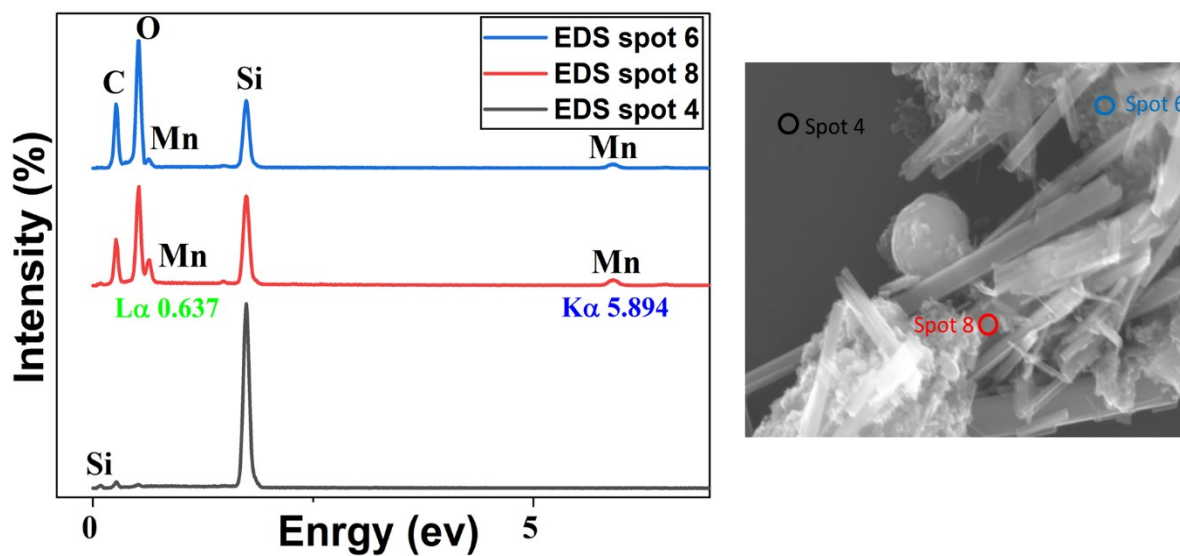
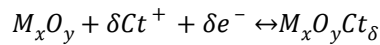


Figure S 9. EDS spectra of $\text{MnO}_x/\text{Mn}_3\text{O}_4$ -rGO prepared under 8 min ablation on a Si wafer confirming presence of Mn, C, and O components on the Si by EDS and STEM measurements

Proposed sequence of lithiation reactions and surface redox reactions in the printed-supercapacitor cell:

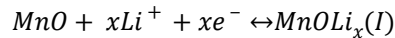
According to Choi *et al.*, for pseudocapacitive materials, there are two main mechanisms of charge storage: surface redox pseudocapacitance and intercalation pseudocapacitance¹.

In general case, the surface redox transformation and ion intercalation into metal-oxide electrode can be written as²:

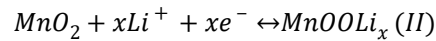


Therefore, to modify surface adsorption of electrolyte cations (Li⁺) on the Mn oxide for the 3-electrode system using Ag/AgCl as a reference electrode, we suggest the following reactions^{3,4}:

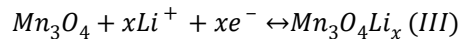
1. MnO



2. MnO₂

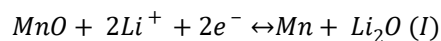


3. Mn₃O₄

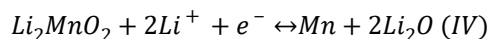
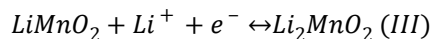
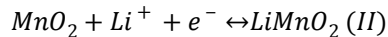


Also, the sequence of proposed reversible faradaic reactions occurring during the discharging process at the interface between the redox-active electrode and gel polymer electrolyte for the various manganese-oxide phases is detailly outlined below⁵:

1. MnO



2. MnO₂



3. Mn₃O₄

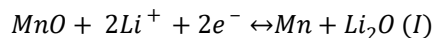
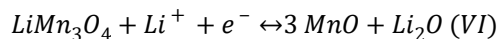
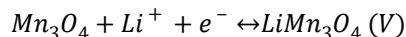


Table 1. Power and Energy density of printed SCs.

Sample	Specific current of GCD [A/g]	Power Density [W/kg]	Energy density [Wh/kg]
Commercial Ink	1	906	17.1
Synthesized Ink	1	1002	32.8

References:

- Choi, C., Ashby, D. S., Butts, D. M., DeBlock, R. H., Wei, Q., Lau, J., & Dunn, B., Achieving high energy density and high-power density with pseudocapacitive materials. *Nature Reviews Materials*, 2020, 5(1), 5-19.
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